

12-29-2000

Form PTO 1595  
(Rev. 6-93)  
OMB No 651-0011 (exp. 4/94)



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Hideo Horiguchi

Additional name(s) of conveying party(ies) attached?  Yes  No

3. Nature of conveyance:

- Assignment  Merger
- Security Agreement  Change of Name
- Other

Execution Date: December 11, 2000

2. Name and address of receiving party(ies):

Name: Sinwa Co., Ltd.

Internal Address:

Street Address: 13-1, Sankaku-Cho, Hanamigawa-KU, Chiba-shi

City: Chiba-ken State: JAPAN Zip:

Additional name(s) & address(es) attached?  Yes  No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: December 11, 2000

A. Patent Application No.(s)

09738 595

B. Patent No. 2628225265Us

EXPRESS MAIL CERTIFICATE  
Date: 12/15/00 Label No. 2628225265Us

I hereby certify that, on the date indicated above, this paper or copy was deposited with the U.S. Postal Service & that it was addressed for delivery to the Assistant Commissioner for Patents, Washington, DC 20231 by "Express Mail Post Office to Addressee" service.

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5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Darby & Darby P.C.

Internal Address: S. Peter Ludwig, Esq.

Street Address: 805 Third Avenue, 27th Floor

City: New York State: New York Zip: 10022-7513

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$40.00

- Enclosed
- Authorized to be charged to deposit account

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04-0100

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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

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OSP-9965  
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Attorney Docket No. \_\_\_\_\_

**ASSIGNMENT**

I/We, the inventor(s) named below [hereinafter referred to as the Assignor(s)], have made an invention entitled:  
CONNECTING STRUCTURE FOR PIECES OF A STRAP MADE OF HARD MATERIALS  
for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

filed on \_\_\_\_\_, Serial No. \_\_\_\_\_, and

(Full Name, Address, and Nationality of Assignee(s))

SINWA CO., LTD.  
13-1, Sankaku-cho, Hanamigawa-ku, Chiba-shi, Chiba-ken, Japan  
Nationality: Japan

[hereinafter referred to as the Assignee(s)], is/are desirous of securing the entire right, title, and interest in and to this invention, the application for United States Patent for this invention, and the Letters Patent to be issued upon this application;

Now, therefore, be it known that, for good and valuable consideration, the receipt of which from the Assignee(s) is hereby acknowledged, I/we, as Assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee(s), its/their lawful successors and assigns, my/our entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof ; and I/we hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention in the name of the Assignee(s), its/their successors and assigns, in accordance with the terms of this assignment;

And I/we hereby further covenant and agree that I/we will, without further consideration, communicate with the Assignee(s), its/their successors and assigns, any facts known to me/us respecting this invention and testify in any legal proceeding, sign all lawful documents when called upon to do so, execute and deliver all documents that may be necessary or desirable to perfect the title to this invention in the name of the Assignee(s), its/their successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid the Assignee(s) and its/their successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such documents shall be borne by the Assignee(s), its/their successors and assigns.

Full name of (check one) <input checked="" type="checkbox"/> Sole or <input type="checkbox"/> First Assignor	
Signature <u>Hideo Horiguchi</u>	Date <u>December 11, 2000</u>
Type <u>Hideo Horiguchi</u>	Citizenship <u>Japan</u>